



## Augmented Reality for the Smart Factories of the Future

Guest Editor:

**Prof. Dr. Anna Syberfeldt**

Department of Production and  
Automation Engineering,  
University of Skövde, P.O. Box  
408, SE-541 28 Skövde, Sweden

Deadline for manuscript  
submissions:

**closed (15 October 2021)**

### Message from the Guest Editor

The Special Issue aims to collect recent innovative research on augmented reality in smart factories. Scientific contributions, ranging from basic research to applied research with pilot industrial applications and demos, are welcome.

- augmented reality
- virtual reality
- mixed reality
- smart factory
- intelligent manufacturing
- cyber-physical systems
- Industry 4.0
- Internet of Things
- industrial digitalisation
- smart manufacturing





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**Prof. Dr. Giulio Nicola Cerullo**  
Dipartimento di Fisica,  
Politecnico di Milano, Piazza L.  
da Vinci 32, 20133 Milano, Italy

## Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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*Applied Sciences* Editorial Office  
MDPI, Grosspeteranlage 5  
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